

Is Now Part of



# **ON Semiconductor**®

# To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at <a href="https://www.onsemi.com">www.onsemi.com</a>. Please email any questions regarding the system integration to <a href="https://www.onsemi.com">Fairchild\_questions@onsemi.com</a>.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized applications, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an equif prese



November 2015

# FUSB3301 USB Type-C Controller for Mobile Chargers and Power Adapters

#### **Features**

- Fully Autonomous Type-C Controller
- Supports Type-C Version 1.1
- Fixed Source Mode
- Low Standby Power: I<sub>CC</sub> = 5 µA (Typical)
- VBUS Switch Control
- Advertises Three Standard Type-C VBUS Current Levels (900 mA, 1.5 A, 3.0 A)
- 2 kV HBM ESD Protection
- 10 Lead MLP Package
- V<sub>DD</sub> Operating Range, 3.0 V- 5.5 V

#### Description

The FUSB3301 is an autonomous Source only Type-C controller optimized for mobile chargers and power adapters. It broadcasts the available current of the charger over CC1/CC2 using the USB Type-C standard and prevents VBUS from being asserted until a valid connection has been verified. It can be used for up to 15 W charging using Type-C protocols. The FUSB3301 has very low standby power consumption and is packaged in a 0.5 mm pitch MLP to accommodate power adapter PCBs.

#### Applications

- USB Type-C Power Ports
- Mobile Chargers
- Power Adapters
- AC-DC Adapters



#### **Ordering Information**

Part Number	Top Mark Operating Temperature Range		Package	Packing Method	
FUSB3301MPX	NZ	-40 to 85°C	10-Lead, MLP, 3 mm x 3 mm	Tape and Reel	



Pin #	Name	Туре	Description
1	CC1	Input/Output	Type-C Configuration Channel
2	NC1 <sup>(1)</sup>	NC	No Connect
3	NC2 <sup>(1)</sup>	NC	No Connect
4	NC3 <sup>(1)</sup>	NC	No Connect
5	HOST1	Input	Host Current Select Pin with Internal Pull-up
6	HOST2	Input	Host Current Select Pin with Internal Pull-up
7	SW	Output	Open Drain output to control the VBUS load switch
8	GND	Power	Ground
9	VDD	Power	Power Supply
10	CC2	Input/Output	Type-C Configuration Channel

#### Note:

1. No connect pins can float or can be tied to ground.

Table 1. Co	nnection State T	able	
CC1	CC2	SW	Description
NC	NC	HiZ	No Attach
Rd	NC	L	Attach to UFP (Sink)
NC	Rd	L	Attach to UFP (Sink)
Rd	Rd	HiZ	No Attach
Ra	NC	HiZ	No Attach
NC	Ra	HiZ	No Attach
Ra	Ra	HiZ	No Attach

#### **Host Current**

#### Table 2. HOST Input Truth Table

HOST2	HOST1	CC Current (µA)	Host Current (A)
GND / LOW	GND / LOW	330	3.0
GND / LOW	FLOAT / HIGH	180	1.5
FLOAT / HIGH	GND / LOW	180	1.5
FLOAT / HIGH	FLOAT / HIGH	80	0.9

#### Source Attach Flowchart



FUSB3301 — USB Type-C Controller for Mobile Chargers and Power Adapters

## **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Pa	arameter		Min.	Max.	Unit
V <sub>DD</sub>	Supply Voltage					V
V <sub>CCX</sub>	CC pins when configured as HOST	-		-0.5	6.0	V
T <sub>STORAGE</sub>	Storage Temperature Range			-65	+150	С
TJ	Maximum Junction Temperature				+150	С
TL	Lead Temperature (Soldering, 10 s	seconds)	econds)			С
		Connector Pins (VBUS,	Air Gap	15		
	TEC 01000-4-2 System ESD	CC1 & CC2)	Contact	8		ĸv
ESD	Human Body Model, JEDEC	Connector Pins (VBUS, C	CC1 and CC2)	4		k)/
	JESD22-A114	Others		2	6.0 6.0 +150 +260	κv
	Charged Device Model, JEDEC JESD22-C101	All Pins		1		kV

#### **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Тур.	Max.	Unit
V <sub>DD</sub>	Supply Voltage	3.0	5.0	5.5	V
T <sub>A</sub>	Operating Ambient Temperature	-40		+85	С
TJ	Operating Junction Temperature	-40		+125	С

#### **DC and Transient Characteristics**

All typical values are at  $T_A=25^{\circ}C$  unless otherwise specified.

Symbol	Parameter			T <sub>A</sub> = -40 to +85°C T <sub>J</sub> =-40 to +125°C			
-		Min.	Тур.	Max.			
I <sub>80_CCX</sub>	Source 80 µA CC Current (Default) HOST2=VDD, HOST1=VDD	64	80	96	μA		
I <sub>180_CCX</sub>	Source 180 µA CC Current (1.5 A) HOST2=VDD, HOST1=GND or HOST2=GND, HOST1=VDD	166	180	194	μA		
I <sub>330_CCX</sub>	Source 330 µA CC Current (3 A) HOST2=GND, HOST1=GND	304	330	356	μΑ		
zOPEN	CC Resistance for Disabled State	126			kΩ		
vRa-SRCdef	Ra Detection Threshold for CC Pin for Source for Default Current on VBUS	0.15	0.20	0.25	V		
vRa-SRC1.5A	Ra Detection Threshold for CC pin for Source for 1.5 A Current on VBUS	0.35	0.40	0.45	V		
vRa-SRC3A	Ra Detection Threshold for CC Pin for Source for 3 A Current on VBUS	0.75	0.80	0.85	V		
vRd-SRCdef	Rd Detection Threshold for Source for Default Current (HOST2/1=VDD/VDD)	1.50	1.60	1.65	V		
vRd-SRC1.5A	Rd detection threshold for Source for 1.5 A Current (HOST2/1=GND/VDD or VDD/GND)	1.50	1.60	1.65	V		
vRd-SRC3A	Rd Detection Threshold for Source for 3 A Current (HOST2/1=GND/GND)	2.45	2.60	2.75	V		

## **Current Consumption**

Symbol	Parameter	Conditions	V <sub>DD</sub> (V)	T <sub>A</sub> = -40 to +85°C T <sub>J</sub> =-40 to +125°C			Unit
				Min.	Тур.	Max.	
Istby	Unattached Source	Nothing attached, Host Pins = VDD, GND, Float.	3.0 to 5.5		5	20	μA
lattach	Attach Current (Less Host Current)	Attached, Host Pins=VDD, GND, Float.	3.0 to 5.5		10	15	μA

## **Timing Parameters**

Symbol Parameter		T <sub>A</sub> = -40 to +85°C T <sub>J</sub> =-40 to +125°C			Unit
			Тур.	Max.	
tCCDebounce	Time from CC Voltage Detection until SW goes LOW	100	150	200	ms
tPDDebounce	Time from CC Voltage Not Detected until SW goes to High-Z	10	15	20	ms

#### **IO Specifications**

Symbol	Parameter	Conditions	V <sub>DD</sub> (V)	T <sub>A</sub> = · T <sub>J</sub> =-4	-40 to +8 0 to +12	Unit	
				Min.	Тур.	Max.	
Volsw	SW Output Low Voltage	I <sub>OL</sub> =4 mA	3.0 to 5.5			0.4	V
VILHOST	HOST1/2 Low-Level Input Voltage		3.0 to 5.5			$0.3V_{DD}$	V
VIHHOST	HOST1/2 High-Level Input Voltage		3.0 to 5.5	$0.7V_{DD}$			V



ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor haves against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death a

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC